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# N-Channel PowerTrench<sup>®</sup> SyncFET<sup>TM</sup> 30 V, 49 A, 1.9 m $\Omega$

### Features

- Max  $r_{DS(on)}$  = 1.9 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 28 A
- Max  $r_{DS(on)}$  = 2.4 m $\Omega$  at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 23 A
- Advanced Package and Silicon Combination for Low r<sub>DS(on)</sub> and High Efficiency
- SyncFET Schottky Body Diode
- MSL1 Robust Package Design
- 100% UIL Tested
- RoHS Compliant

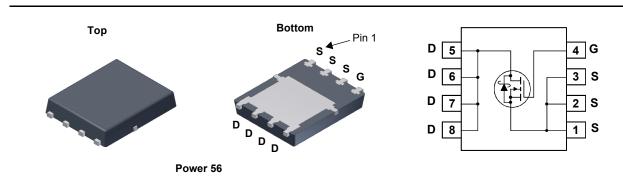


### **General Description**

The FDMS0302S has been designed to minimize losses in power conversion application. Advancements in both silicon and package technologies have been combined to offer the lowest  $r_{DS(on)}$  while maintaining excellent switching performance. This device has the added benefit of an efficient monolithic Schottky body diode.

### Applications

- Synchronous Rectifier for DC/DC Converters
- Notebook Vcore/ GPU Low Side Switch
- Networking Point of Load Low Side Switch



### MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted.

Symbol	Parameter			Ratings	Units		
V <sub>DS</sub>	Drain to Source Voltage			30	V		
V <sub>GS</sub>	Gate to Source Voltage		(Note 4)	±20	V		
	Drain Current -Continuous (Package limited) T <sub>C</sub> = 25 °C			49			
	-Continuous (Silicon limited) T <sub>C</sub> = 25 °C			177	•		
I <sub>D</sub>	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	29	Α		
	-Pulsed			150			
E <sub>AS</sub>	Single Pulse Avalanche Energy	162	mJ				
D	Power Dissipation	T <sub>C</sub> = 25 °C		89			
P <sub>D</sub>	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.5			
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C		

$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.4	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1	a) 50	C/VV

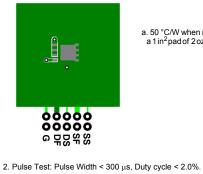
### Package Marking and Ordering Information

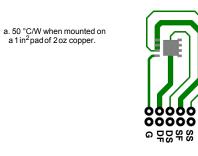
Dev	vice Marking	Device	Package	Reel Size	Tape Width	Quantity
F	DMS0302S	FDMS0302S	Power 56	13 "	12 mm	3000 units

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units	
Off Chara	octeristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 1 mA, V <sub>GS</sub> = 0 V	30			V	
BV <sub>DSSt</sub>	Drain to Source Breakdown Voltage (transient)	$V_{GS} = 0 V$ , $I_{D(aval)} = 8.6 A$ , $T_{case} = 25 °C$ , $t_{transient} = 10 ns$	34			V	
$\Delta BV_{DSS}$ $\Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D$ = 10 mA, referenced to 25 °C		23		mV/°C	
DSS	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 24 V, V <sub>GS</sub> = 0 V			500	μA	
I <sub>GSS</sub>	Gate to Source Leakage Current, Forward	V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V			100	nA	
On Chara	cteristics (Note 2)						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 1 \text{ mA}$	1.2	1.7	3.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D$ = 10 mA, referenced to 25 °C		-5		mV/°C	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 28 A		1.5	1.9		
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 23 A		1.9	2.4		
- ( - )		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 28 A, T <sub>J</sub> = 125 °C		2.0	2.6		
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 28 A		181		S	
Dynamic	Characteristics						
C <sub>iss</sub>	Input Capacitance	V 45.V.V. 0.V.		5525	7350	pF	
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		2020	2685	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance			150	230	pF	
R <sub>g</sub>	Gate Resistance			0.4	0.9	Ω	
Switching	g Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time			20	36	ns	
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 15 V, I <sub>D</sub> = 28 A,		8	17	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$		43	70	ns	
t <sub>f</sub>	Fall Time	1		5	10	ns	
Q <sub>a</sub>	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		78	109	nC	
Q <sub>q</sub>	Total Gate Charge	$V_{GS} = 0 \text{ V to } 4.5 \text{ V} \text{ V}_{DD} = 15 \text{ V},$		35	49	nC	
Q <sub>gs</sub>	Gate to Source Gate Charge	I <sub>D</sub> = 28 A		16.4		nC	
Q <sub>gd</sub>	Gate to Drain "Miller" Charge	1 1		6.6		nC	
-	urce Diode Characteristics						
Jan - 301		$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.38	0.7		
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{ij} = 0 V_{ij} = 20 A \qquad (Note 2)$		0.00	4.0	V	

V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)	0.38	0.7	V
		V <sub>GS</sub> = 0 V, I <sub>S</sub> = 28 A (Note 2)	0.74	1.2	
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 28 A, di/dt = 300 A/μs	46	75	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$r_{\rm F} = 20$ A, $u_{\rm F} u_{\rm F} = 300$ A/ $\mu$ s	73	117	nC

Notes: 1. R<sub>0JA</sub> is determined with the device mounted on a 1in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0JC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.



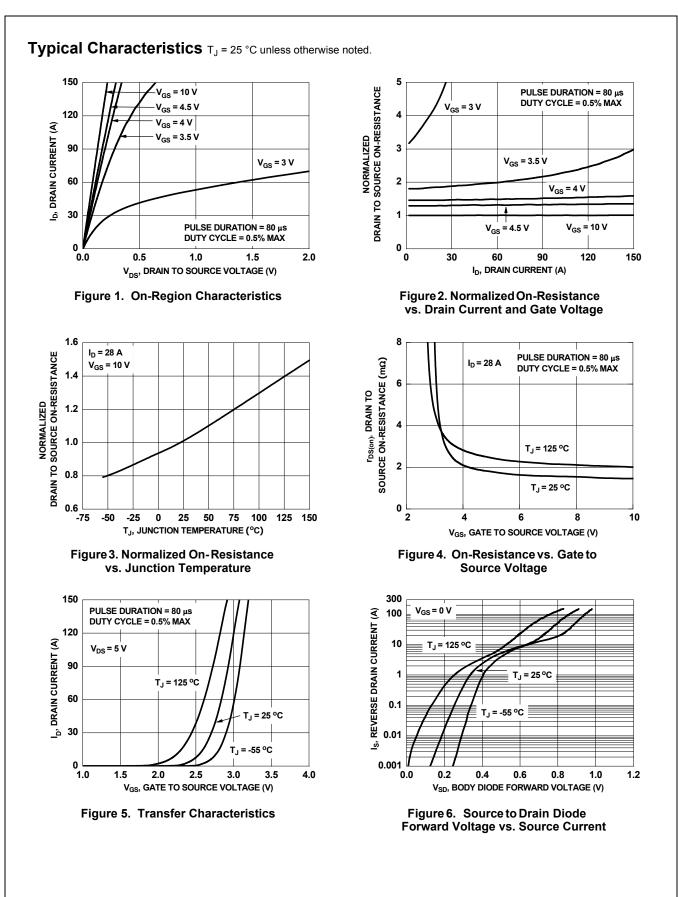


b.125 °C/W when mounted on a minimum pad of 2 oz copper.

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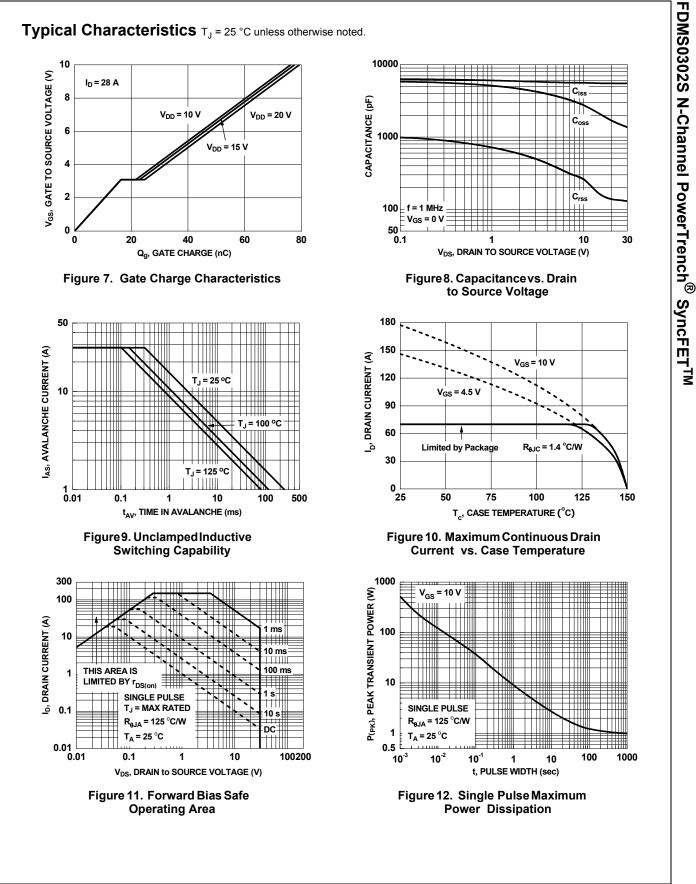
FDMS0302S N-Channel PowerTrench<sup>®</sup> SyncFET<sup>TM</sup>

3.  $E_{AS}$  of 162 mJ is based on starting  $T_J$  = 25 °C, L = 1 mH,  $I_{AS}$  = 18 A,  $V_{DD}$  = 27 V,  $V_{GS}$  = 10 V. 100% test at L = 0.3 mH,  $I_{AS}$  = 28 A. 4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied. FDMS0302S Rev.1.4



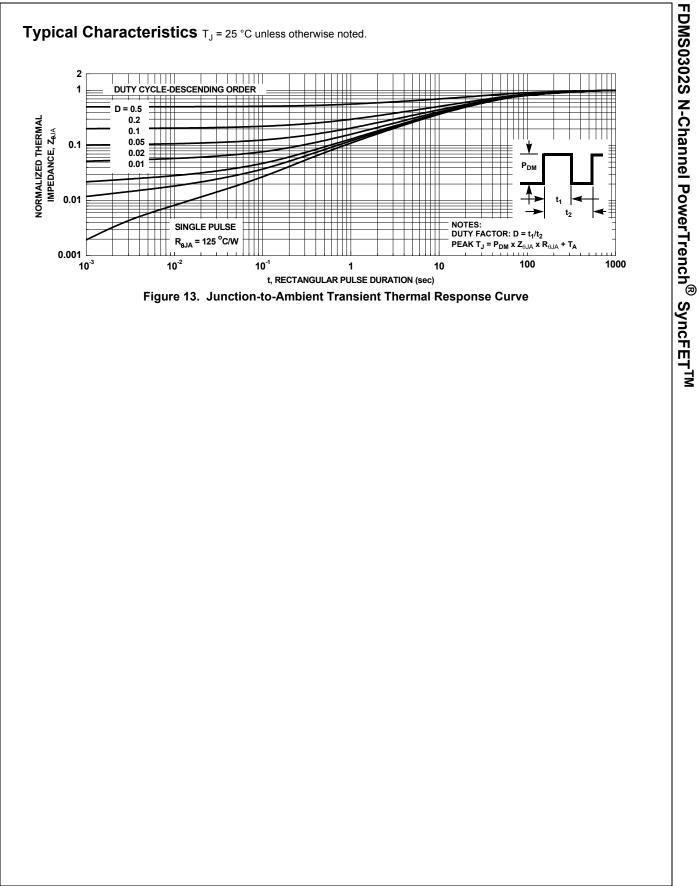
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# FDMS0302S N-Channel PowerTrench<sup>®</sup> SyncFET<sup>TM</sup>

### Typical Characteristics (continued)

### SyncFET Schottky Body Diode Characteristics

Fairchild's SyncFET process embeds a Schottky diode in parallel with PowerTrench MoSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 14 shows the reverses recovery characteristic of the FDMS0302S.

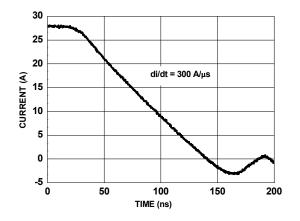
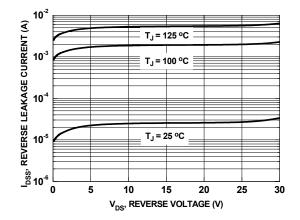
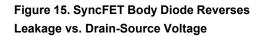


Figure 14. FDMS0302S SyncFET Body Diode Reverse Recovery Characteristic

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.







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